

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JONG SEOG LEE	08/26/2021
JAMES SANGYOUNG OH	08/26/2021
RECEIVING PARTY DATA	
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State/Country:	CALIFORNIA
Postal Code:	92108
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17383244
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ATTORNEY DOCKET NUMBER:	121362-0021UT01
NAME OF SUBMITTER:	SHARI L. HERRON
SIGNATURE:	/Shari L. Herron/
DATE SIGNED:	08/26/2021
Total Attachments: 2	
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ASSIGNMENT

WHEREAS, WE Jong Seog Lee and James Sangyoung Oh (hereinafter referred to as "ASSIGNORS"), have invented a certain invention entitled "THERMAL MONITORING SYSTEM FOR TRAILER WHEEL AREA" for which U.S. patent application no. 17/383,244 was filed on July 22, 2021; and;

AND WHEREAS, Hyundai Translead, a California corporation, with offices at 8880 Rio San Diego Drive, Suite 600, San Diego, CA, 92108 (hereinafter referenced as ASSIGNEE are desirous of securing all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in return for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including all provisional applications relating thereto, any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or their designee(s), as ASSIGNEE or their successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at their own expense;

And I further agree that ASSIGNEE will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I further agree that this Assignment shall be deemed to have been made and executed in the State of California and any dispute arising hereunder not governed by US federal law will be resolved in accordance with the laws of the State of California without reference to its conflict of law principles. I hereby consent and submit to the jurisdiction of the federal and state courts located in the State of California. Any action or suit under this Agreement or otherwise arising from the relationship between the parties will only be brought in any federal or state court with appropriate jurisdiction over the subject matter hereof sitting in the State of California. I WILL NOT RAISE IN CONNECTION HEREWITH, AND HEREBY WAIVE, TRIAL BY JURY

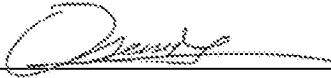
AND/OR ANY DEFENSES BASED UPON THE VENUE, THE INCONVENIENCE OF THE FORUM, THE LACK OF PERSONAL JURISDICTION, THE SUFFICIENCY OF SERVICE OF PROCESS OR THE LIKE IN ANY ACTION OR SUIT ARISING FROM SUCH DISPUTE;

I agree that all my obligations hereunder shall survive any termination of my employment and shall be binding on my heirs, executors, administrators, or other legal representatives or assigns; This assignment is executed on the date indicated below.



Jong Seog Lee

Date: August 26, 2021



James Sangyoung Oh

Date: 08/26/2021